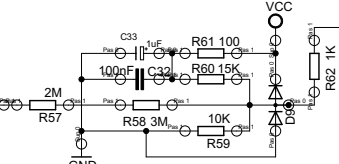
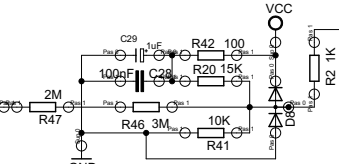
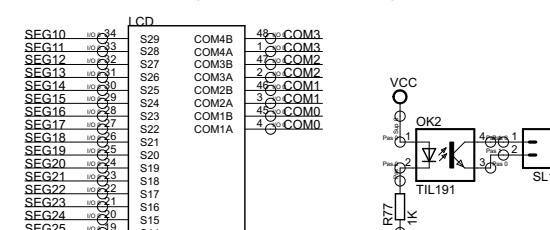
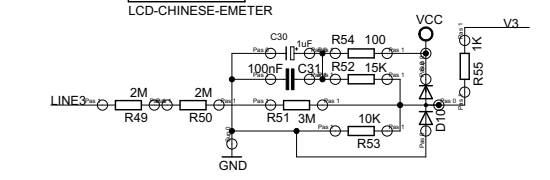


MSP430F449IFZ



SEG	Pin	SEG	Pin
SEG10	10	SEG29	29
SEG11	11	SEG30	30
SEG12	12	SEG31	31
SEG13	13	SEG32	32
SEG14	14	SEG33	33
SEG15	15	SEG34	34
SEG16	16	SEG35	35
SEG17	17	SEG36	36
SEG18	18	SEG37	37
SEG19	19	SEG38	38
SEG20	20	SEG39	39
SEG21	21		
SEG22	22		
SEG23	23		
SEG24	24		
SEG25	25		
SEG26	26		
SEG27	27		
SEG28	28		
SEG29	29		
SEG30	30		
SEG31	31		
SEG32	32		
SEG33	33		
SEG34	34		
SEG35	35		
SEG36	36		
SEG37	37		
SEG38	38		
SEG39	39		



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